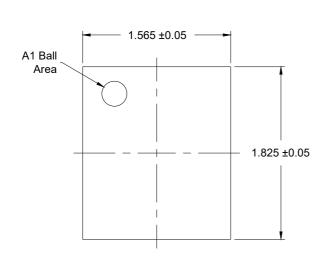
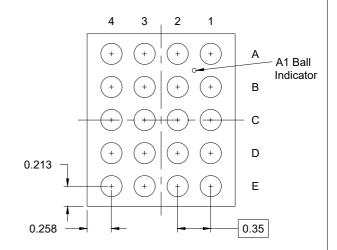




Package Code: AWQ20D1 20-WLCSP 1.565 x 1.825 x 0.50 mm Body, 0.35mm Pitch

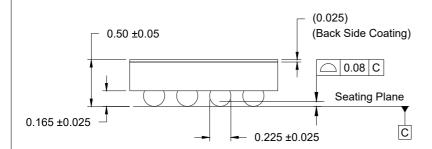
PSC-4961-01, Revision: 04, Date Created: Mar 08, 2023



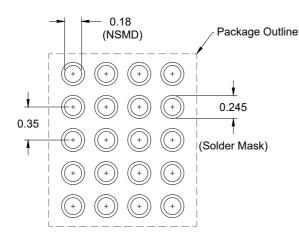


TOP VIEW

BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN

(PCB Top View, NSMD Design)

NOTES:

- JEDEC compatible..
- 2. All dimensions are in mm and angles are in degrees.
- Use ±0.05 mm for the non-toleranced dimensions. 3.
- Numbers in () are for references only.
- Pre-reflow solder ball diameter is Ø0.21 mm.
- UBM diameter is Ø0.20 mm.